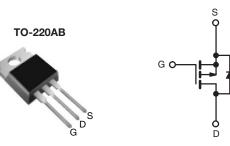


Vishay Siliconix



Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 60				
R _{DS(on)} (Ω)	$V_{GS} = -10 V$	0.50			
Q _g (Max.) (nC)	12				
Q _{gs} (nC)	3.8				
Q _{gd} (nC)	5.1				
Configuration	Single				



P-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Land (Dh) free	IRF9Z10PbF
Lead (Pb)-free	SiHF9Z10-E3
SnPb	IRF9Z10
SILED	SiHF9Z10

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	- 60	v	
Gate-Source Voltage			V _{GS}	± 20	v	
Continuous Drain Current	$V_{GS} \text{ at - 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$		- 6.7			
	V _{GS} at - 10 V	T _C = 100 °C	ID	- 4.7	А	
Pulsed Drain Current ^a			I _{DM}	- 27	1	
Linear Derating Factor			0.29	W/°C		
Single Pulse Avalanche Energy ^b			E _{AS}	140	mJ	
Repetitive Avalanche Current ^a			I _{AR}	- 6.7	А	
Repetitive Avalanche Energy ^a			E _{AR}	4.3	mJ	
Maximum Power Dissipation	T _C = 25 °C		PD	43	W	
Peak Diode Recovery dV/dt ^c	•		dV/dt	- 4.5	V/ns	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175	°C		
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	-0	
Mounting Torque	6.00.00	0.00		10	lbf · in	
	6-32 or M3 screw			1.1	N⋅m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. V_{DD} = - 25 V, starting T_J = 25 °C, L = 6.23 mH, R_g = 25 Ω , I_{AS} = - 6.7 A (see fig. 12).

c. $I_{SD} \le$ - 6.7 A, dI/dt \le 90 A/µs, $V_{DD} \le$ V_{DS} , $T_J \le$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R _{thJA}	- 62 0.50 - - 3.5						
Case-to-Sink, Flat, Greased Surface	R _{thCS}				°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 °C, u	inless otherw	ise noted)						
PARAMETER	SYMBOL	1	CONDITI	IONS	MIN.	TYP.	MAX.	UNIT
Static	STRIBUE	1231	CONDITI		IVIIIA.	116.		UNIT
	V	V - 0		250	- 60	_		Ň
Drain-Source Breakdown Voltage	V _{DS}		$V, I_D = -2$				-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference			-	- 0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$		- 2.0	-	- 4.0	V	
Gate-Source Leakage	I _{GSS}		$GS = \pm 20$		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 150 \text{ °C}$		-	-	- 100	μA	
				-	-	- 500		
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V			-	-	0.50	Ω
Forward Transconductance	9 _{fs}	$V_{DS} = -25 \text{ V}, \text{ I}_{D} = -4.0 \text{ A}^{b}$			1.4	-	-	S
Dynamic	•	-						
Input Capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5		-	270	-	pF	
Output Capacitance	C _{oss}			-	170	-		
Reverse Transfer Capacitance	C _{rss}			-	31	-		
Total Gate Charge	Qg				-	-	12	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V		6.7 A, V _{DS} = - 48 V, e fig. 6 and 13 ^b	-	-	3.8	nC
Gate-Drain Charge	Q _{gd}		300 1		-	-	5.1	
Turn-On Delay Time	t _{d(on)}		•		-	11	-	
Rise Time	t _r	$V_{DD} = - 30 \text{ V}, \text{ I}_{D} = - 6.7 \text{ A}, \\ \text{R}_{g} = 24 \ \Omega, \text{ R}_{D} = 4.0 \ \Omega, \text{ see fig. } 10^{\text{b}}$		-	63	-	ns	
Turn-Off Delay Time	t _{d(off)}			-	10	-		
Fall Time	t _f			-	31	-		
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal Source Inductance	L _S			-	7.5	-		
Drain-Source Body Diode Characteristic	cs							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 6.7	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	- 27		
Body Diode Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = -6.7 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	- 5.5	V	
Dody Diode Voltage	• 30							
Body Diode Reverse Recovery Time	t _{rr}			(), , oc. ; ; ; ;	-	80	160	ns
, ,		T _J = 25 °C, I _F =	- 6.7 A, dl	/dt = 100 A/µs ^b	-	80 0.096	160 0.19	ns µC

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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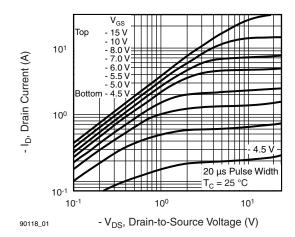


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

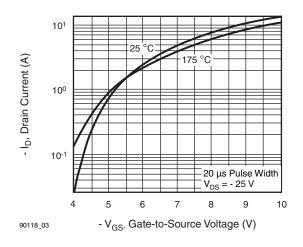


Fig. 3 - Typical Transfer Characteristics

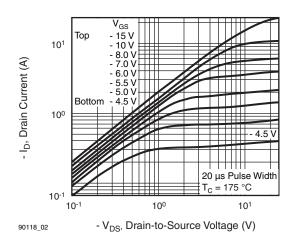


Fig. 2 - Typical Output Characteristics, T_C = 175 ° C

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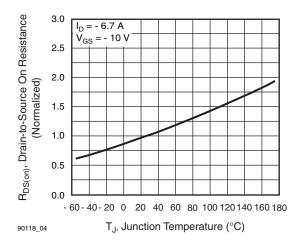


Fig. 4 - Normalized On-Resistance vs. Temperature

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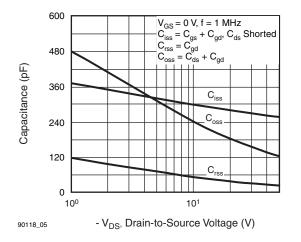


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

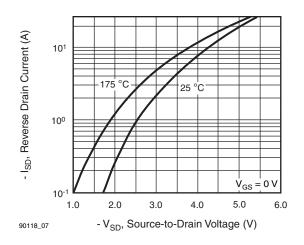


Fig. 7 - Typical Source-Drain Diode Forward Voltage

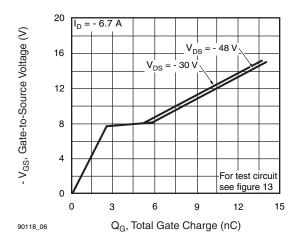


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

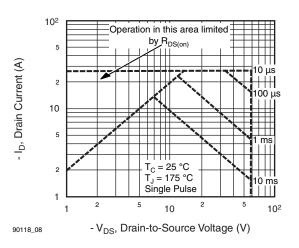


Fig. 8 - Maximum Safe Operating Area

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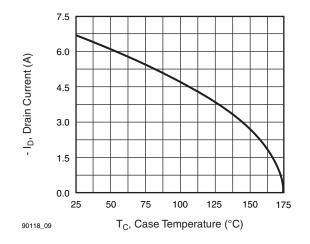


Fig. 9 - Maximum Drain Current vs. Case Temperature

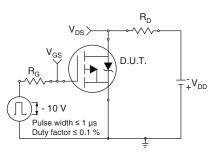


Fig. 10a - Switching Time Test Circuit

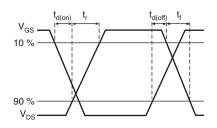


Fig. 10b - Switching Time Waveforms

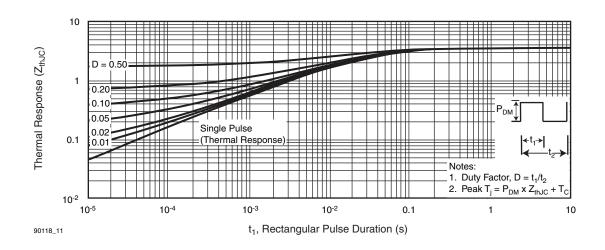


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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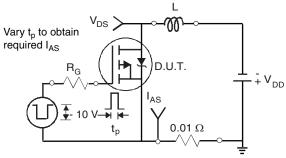


Fig. 12a - Unclamped Inductive Test Circuit

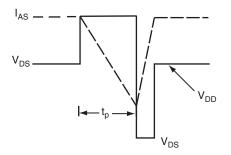


Fig. 12b - Unclamped Inductive Waveforms

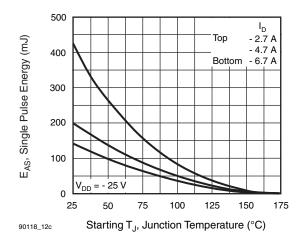


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

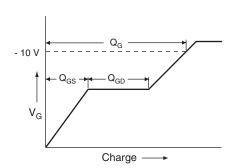


Fig. 13a - Basic Gate Charge Waveform

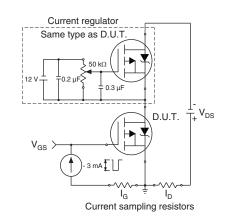


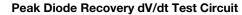
Fig. 13b - Gate Charge Test Circuit

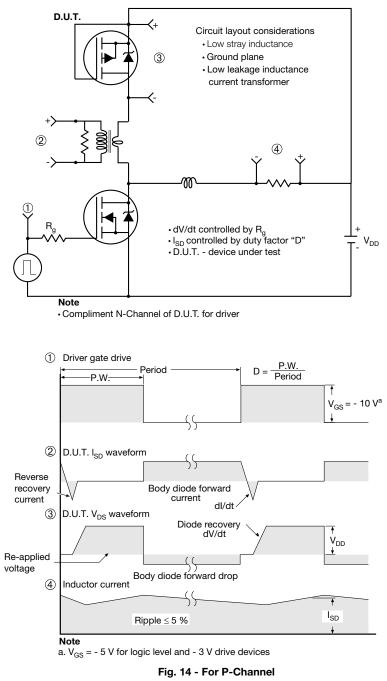
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